Application No.: Not Yet Assigned Docket No.: 313632001700

## AMENDMENTS TO THE CLAIMS

1. (currently amended) Method A method for selectively metallizing a component which component comprises a first part-(1), constituted by a first material, and a second part-(2), constituted by a second material, the method comprising next sequential the steps of:

[[-]] (a) applying a metallizing seed layer (6) is applied on at least a part of the surface of said first part and of said second part;

[[- the]] (b) exposing a relevant surface of the component, including said metallizing seed layer, is exposed to a solvent (7) in which the material of said first part (1) is soluble and the material of said second part (2) is not soluble, thereby providing a metallizing seed layer on said second part but not on said first part.

- 2. (currently amended) Method according to The method of claim 1, in which wherein the first material and/or the second material is a plastic or polymer.
- 3. (currently amended) Method according to The method of claim 1, in which wherein the first material and/or the second material is a ceramic material.
- 4. (currently amended) Method according to The method of claim1, followed by a step wherein which further includes the step of exposing the surface of the component is exposed to a metallizing environment—(9).
- 5. (currently amended) System A system for metallizing a component that comprises a first part-(1), constituted by a first material, and a second part-(2), constituted by a second material, the system comprising:

means for producing a metallizing seed layer (6) at the surface on at least a part of said first part and of said second part, and, moreover,

means for <u>exposing</u> the relevant surface of the component, including said metallizing seed layer, to be exposed to a solvent (7) in which the material of said first part (1) is soluble and the material of said second part (2) is not.

6. (currently amended) Component A component comprising a first part-(1), constituted by a first material, and a second part-(2), constituted by a second material, said second part of the component comprising a metallizing seed layer (8), the which surface of said

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first part (1) being is soluble and the surface of said second part (2) being is not soluble in at least one specific solvent, and

wherein the second part but not the first part comprises a metallizing seed layer.

- 7. (currently amended) Component according to The component of claim 6, in which the first material and/or the second material is a plastic or polymer material.
- 8. (currently amended) Component according to The component of claim 6, in which the first material and/or the second material is a ceramic material.
- 9. (currently amended) Component according to The component of claim 6, wherein said seed layer (8) of the second component part (2) being is covered by a metallic layer-(10).
  - 10. (new) The system of claim 5 which further includes: means for providing a metallizing environment.
  - 11. (new) A component obtained by the method of claim 1.
  - 12. (new) A component obtained by the method of claim 4.

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